

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
CHENYANG WANG	06/13/2016
RECEIVING PARTY DATA	
Name:	BEIJING PICO TECHNOLOGY CO., LTD
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15143744
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ATTORNEY DOCKET NUMBER:	BZLF002-US
NAME OF SUBMITTER:	MATTHEW J. CURRAN
SIGNATURE:	/Matthew J. Curran, Reg. No. 71,094/
DATE SIGNED:	06/23/2016
Total Attachments: 2	
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source=BZLF002-US_Assignment_Executed#page2.tif	

ASSIGNMENT

I, the undersigned individual, have invented a **METHOD, SYSTEM AND MODULE FOR ADJUSTING INTERPUPILLARY DISTANCE OF HEAD-MOUNTED 3D DISPLAYS**, (Atty Dkt. No. BZLF002-US) and having on the 13th day of June, 2016, executed declaration for patent as inventor, (and I hereby authorize attorneys and agents associated with USPTO Customer No. **24222** to here insert the filing date and serial number of said application when known, US Application Serial No. 15/143744, filed on the 2nd day of May, 2016 ; PCT Application Serial No. _____, filed on the _____ day of _____, 20) describing the same and based thereon, for good and valuable consideration, receipt of which is hereby acknowledged from BEIJING PICO TECHNOLOGY CO., LTD, 21st Floor, Shining Tower, No. 35 Xueyuan Road, HaiDian District, Beijing, China 100083, hereinafter called Assignee (which term shall include its successors and assigns) do hereby sell, assign and transfer unto Assignee my entire right, title, and interest as inventor, in and throughout the United States of America (including its territories and dependencies), in and to and under said application (which term shall include hereinafter where the context so admits all divisional, continuing, reissue and other patent applications based thereon) and the inventions (which term shall include each and every such invention, or any part thereof) therein described, and any and all patents and like rights of exclusion (including extensions thereof) which may be granted on or for said inventions or on said application;

And for the same consideration I do hereby agree for myself and for my respective heirs, executors and administrators, promptly upon request of the Assignee, to execute and deliver without further compensation any power of attorney, assignment, original, divisional, continuing, reissue or other application or applications for patent or patents or like rights of exclusion in, or other lawful documents and any further assurances that may be deemed necessary or desirable by Assignee to fully secure my said right, title, and interest as aforesaid in and to said inventions, application, and said several patents and like rights of exclusion, or any of them;

And I do hereby authorize and request the Commissioner of Patents of the United States of America to issue to the Assignee any and all patents and like rights of exclusion which may be granted upon said application or on or for said inventions;

And I do hereby covenant for myself and for my respective legal representatives and agree with Assignee that I have granted no right or license to make, use or sell said inventions in the United States of America to anyone except the Assignee, that prior to the execution of this deed my right, title and interest in and to said inventions as the inventor has not been otherwise encumbered, and that I have not executed and will not execute any instrument in conflict herewith.

ASSIGNMENT SIGNATURE PAGE(S) ATTACHED

ASSIGNMENT SIGNATURE PAGE # _____ of _____
(OFFICIANT: REPEAT THIS PAGE AS OFTEN AS NECESSARY TO OBTAIN ALL SIGNATURES)

TITLE: METHOD, SYSTEM AND MODULE FOR ADJUSTING INTERPUPILLARY
DISTANCE OF HEAD-MOUNTED 3D DISPLAYS

ATTY DKT. NO. BZLF002-US

IN WITNESS of these grants and covenants of Assignment, made by me in favor of

(Assignee) BEIJING PICO TECHNOLOGY CO., LTD

I hereunto set my hands and seals.

#1 Chenyang Wang
Chenyang Wang

2016.6.13
Date Signed

Witness signature

Witness Printed Name

Assignment, page 2 of 2.